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گروه فنی مهندسی جوش و برش مقدم

اعتماد از شما کیفیت و تخصص از ما

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مشهد خیام شمالی 63 خیابان پردیس 3

برای کسب اطلاعات بیشتر بر روی لینک ها کلیک کنید

 7 سال سابقه آموزش تعمیرات تخصصی دستگاه های جوش اینورتری تک فاز و 3 فاز

- 7 سال سابقه فروش قطعات الکترونیکی دستگاه جوش
 تک فاز و 3 فاز
- آموزش تخصصی تحلیل دستگاه های جوش اینورتری مختص ابراز فروشان
 - آموزش تخصصی ابراز آلات شارژی

IGBT - Field Stop 600 V, 60 A

FGH60N60SMD

Description

Using novel field stop IGBT technology, ON Semiconductor's newseries of field stop 2nd generation IGBTs offer the optimum

www.onsemi.com

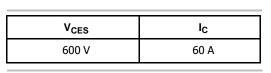
performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

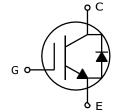
Features

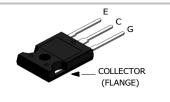
- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.9 \text{ V} (Typ.) @ I_C = 60 \text{ A}$
- High Input Impedance
- Fast Switching: E_{OFF} = 7.5 uJ/A
- Tightened Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant

Applications

• Solar Inverter, UPS, Welder, PFC, Telecom, ESS

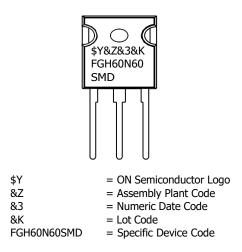






TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.



ABSOLUTE MAXIMUM RATINGS

Symbol	Descript	ion	Ratings	Unit
V _{CES}	Collector to Emitter Voltage	ector to Emitter Voltage		V
V _{GES}	Gate to Emitter Voltage		±20	V
	Transient Gate to Emitter Voltage		±30	V
IC	Collector Current	T _C = 25°C	120	А
		T _C = 100°C	60	А
ICM (Note 1)	Pulsed Collector Current		180	А
IF	Diode Forward Current	T _C = 25°C	60	А
		T _C = 100°C	30	А
I _{FM} (Note 1)	Pulsed Diode Maximum Forward Currer	nt	180	А
PD	Maximum Power Dissipation	T _C = 25°C	600	W
		T _C = 100°C	300	W
Tj	Operating Junction Temperature		–55 to +175	°C
T _{STG}	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for Soldering Purpo	oses, 1/8" from Case for 5 Seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	Тур.	Max.	Unit
R _{0JC} (IGBT)	Thermal Resistance, Junction to Case	-	0.25	°C/W
R _{0JC} (Diode)	Thermal Resistance, Junction to Case	-	1.1	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Qty per Tube
FGH60N60SMD	FGH60N60SMD	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0 V, I_C = 250 \mu A$	600	-	-	V
$\Delta BV_{CES} / \Delta T_J$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 V, I_C = 250 \mu A$	-	0.6	-	V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTE	ERISTICS					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 250 \ \mu A$, $V_{CE} = V_{GE}$	3.5	4.5	6.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V},$	-	1.9	2.5	V
		$ I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V}, \\ T_{C} = 175^{\circ}\text{C} $	_	2.1	_	v
OYNAMIC CHA	RACTERISTICS			.		
Cies	Input Capacitance	$V_{CE} = 30 V, V_{GE} = 0 V,$	-	2915	-	pF
Coes	Output Capacitance	f = 1 MHz	-	270	-	pF
C _{res}	Reverse Transfer Capacitance	1	-	85	-	pF
WITCHING CH	IARACTERISTICS					
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 V, I_C = 60 A,$	-	18	27	ns
Tr	Rise Time	$R_G = 3 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	47	70	ns
T _{d(off)}	Turn–Off Delay Time	1	-	104	146	ns
T _f	Fall Time		-	50	68	ns
Eon	Turn-On Switching Loss		-	1.26	1.94	mJ
E _{off}	Turn–Off Switching Loss		-	0.45	0.6	mJ
E _{ts}	Total Switching Loss		-	1.71	2.54	mJ
T _{d(on)}	Turn–On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 60 \text{ A}, R_{G} = 3 \Omega, V_{GE} = 15 \text{ V},$	-	18	-	ns
Tr	Rise Time	Inductive Load, $T_C = 17^\circ C$	-	41	-	ns
T _{d(off)}	Turn–Off Delay Time		-	115	-	ns
T _f	Fall Time	-	-	48	-	ns
Eon	Turn–On Switching Loss		-	2.1	-	mJ
E _{off}	Turn–Off Switching Loss		-	0.78	-	mJ
E _{ts}	Total Switching Loss		-	2.88	-	mJ
Qg	Total Gate Charge	$V_{CE} = 400 \text{ V}, \text{ I}_{C} = 60 \text{ A},$	-	189	284	nC
Q _{ge}	Gate to Emitter Charge	$V_{GE} = 15 V$	-	20	30	nC
Q _{gc}	Gate to Collector Charge	1	-	91	137	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Symbol	Parameter	Test Co	nditions	Min Typ		Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 30 A	T _C = 25°C	-	2.1	2.7	V
			T _C = 175°C	-	1.7	-	
E _{rec}	Reverse Recovery Energy	I _F = 30 A, di _F /dt = 200 A/µs	T _C = 175°C	-	79	-	uЈ
T _{rr}	Diode Reverse Recovery Time		T _C = 25°C	-	30	39	ns
			T _C = 175°C	-	72	-	
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C	-	44	62	nC
			T _C = 175°C	-	238	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

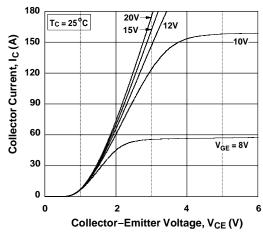
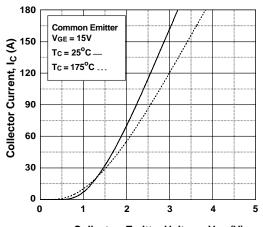


Figure 1. Typical Output Characteristics



Collector-Emitter Voltage, V_{CE} (V)

Figure 3. Typical Saturation Voltage Characteristics

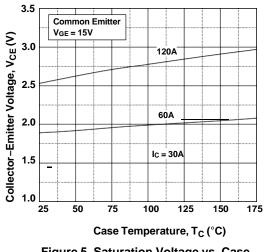


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

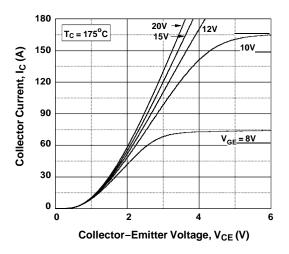
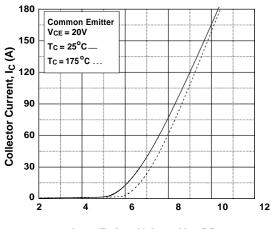


Figure 2. Typical Output Characteristics



Gate-Emitter Voltage, V_{GE} (V)

Figure 4. Transfer Characteristics

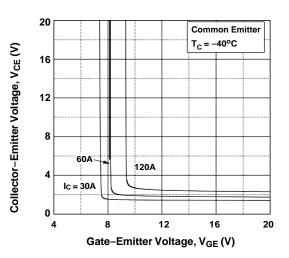


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

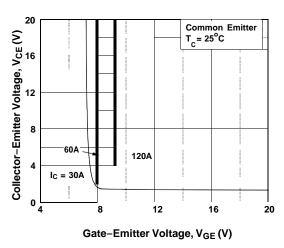


Figure 7. Saturation Voltage vs. V_{GE}

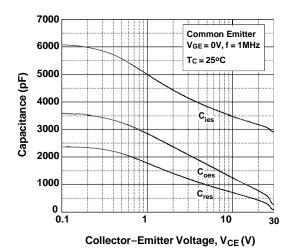


Figure 9. Capacitance Characteristics

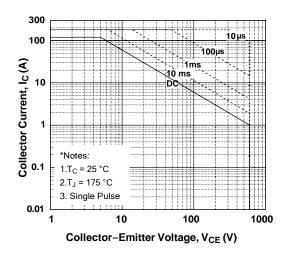
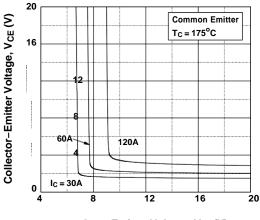


Figure 11. SOA Characteristics



Gate-Emitter Voltage, V_{GE}(V)

Figure 8. Saturation Voltage vs. V_{GE}

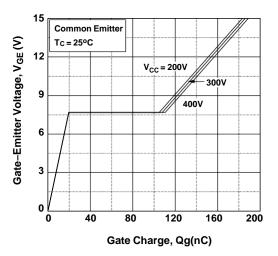
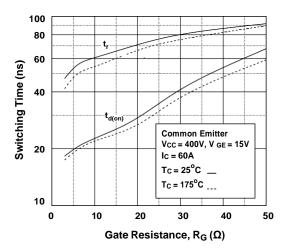
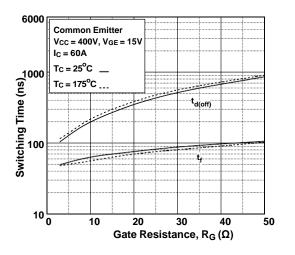


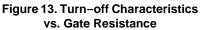
Figure 10. Gate Charge Characteristics

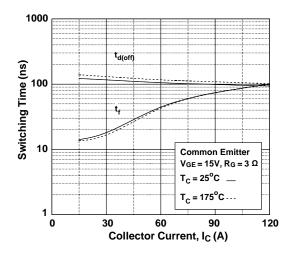


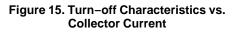


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)









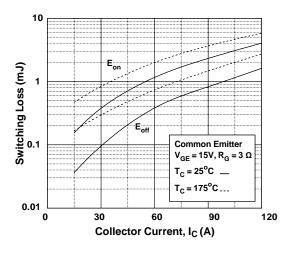


Figure 17. Switching Loss vs. Collector Current

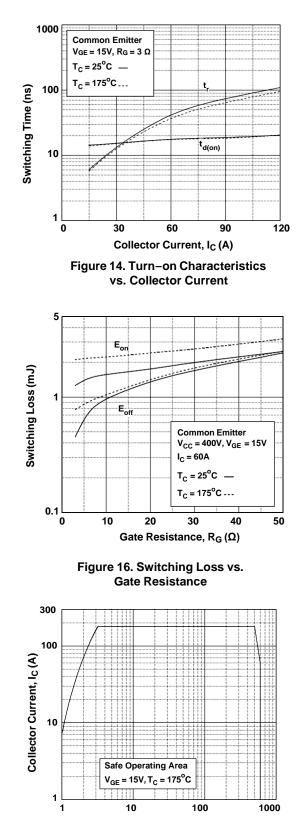
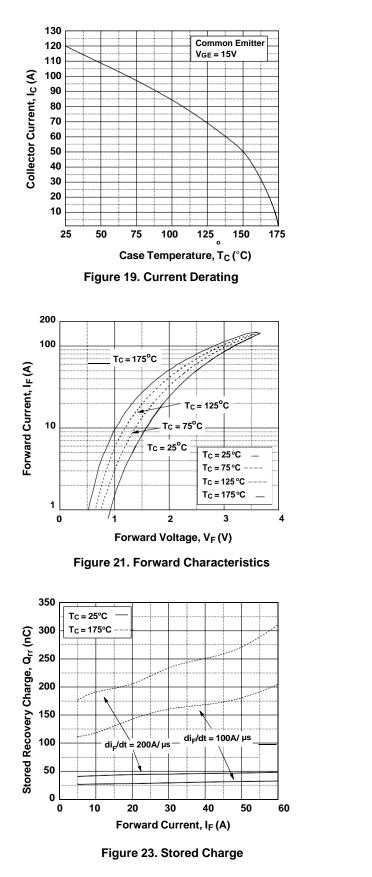




Figure 18. Turn Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



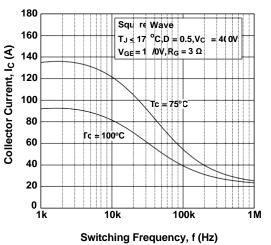


Figure 20. Load Current vs. Frequency

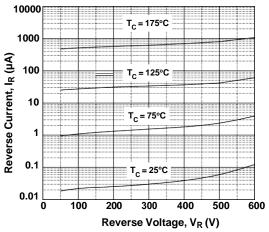


Figure 22. Reverse Current

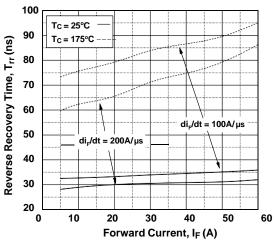


Figure 24. Reverse Recovery Time

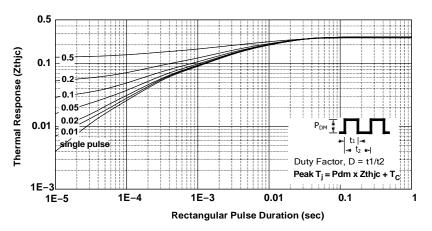


Figure 25. Transient Thermal Impedance of IGBT

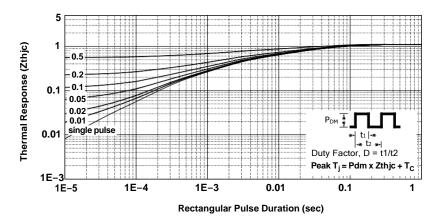
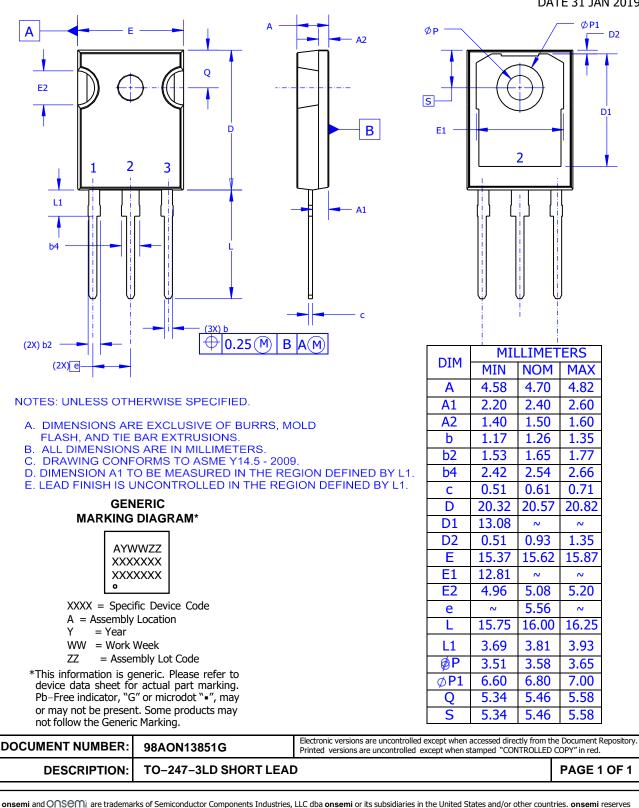


Figure 26. Transient Thermal Impedance of Diode



TO-247-3LD SHORT LEAD CASE 340CK **ISSUE A**

DATE 31 JAN 2019



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